L	Hits	Search Text	DB	Time stamp	_
Number				_i .	
-	24	(thermoset\$4) same (copper or conductor)	USPAT;	2004/09/23	_
		same (resin or adhesive) same (pcb or	US-PGPUB;	14:11	
		(circuit near board)) same (ptfe or	EPO; JPO;		
		polytetrafluoroethylene or fluorpolymer)	DERWENT;		
-			IBM_TDB		
_	48	(thermoset\$4) same (copper or conductor)	USPAT;	2004/09/23	
		same (resin or adhesive) same (pcb or	US-PGPUB;	14:25	
		(circuit near board)) same (coat or	EPO; JPO;		
		coated or coating) same (multilayer or	DERWENT;		
		(multi near layer))	IBM TDB		
-	218	(thermoset\$4) near5 (resin or adhesive)	USPAT;	2004/09/23	
		near5 (coat or coated or coating) near5	US-PGPUB;	14:26	
		(copper or conductor)	EPO; JPO;		J
			DERWENT;		
		7	IBM TDB		
-	16	((thermoset\$4) near5 (resin or adhesive)	USPAT;	2004/09/23	
		near5 (coat or coated or coating) near5	US-PGPUB;	14:26	
		(copper or conductor)) same prepred	EPO; JPO;	1	
		TI FILL TO THE PROPERTY OF THE	DERWENT;		
			IBM TDB		ı
	26	dye near20 resin near20 prepreg	USPAT;	2004/09/23	
		are media resim media propreg	US-PGPUB;	15:47	
			EPO; JPO;	13.47	.]
		i '	DERWENT;		ı
			IBM TDB		ļ
	9	("2569793" "3298959" "3926658"	USPAT	2004/09/23	
	,	"4183767" "4365516" "4392982"	USPAI		
		"4400618" "4538909" "4549206").PN.		15:47	
	5	4697923.URPN.	HCDAM	2004/00/02	- 1
	J	409/923.URPN.	USPAT	2004/09/23	-
_	86	dye near20 resin near20 (fluoropolymer or		15:47	-
	0.0	dye nearzo resin nearzo (fluoropolymer or ptfe or (polytetrafluoroethylene))	USPAT;	2004/09/23	
		pure of (polytetralluoroethylene))	US-PGPUB;	15:49	
			EPO; JPO;		Ì
			DERWENT;		
	_	CE241C0 UPPW	IBM_TDB		
-	0	6534160.URPN.	USPAT	2004/09/23	
		605.4050		15:49	
_	2	6254972.URPN.	USPAT	2004/09/23	
				15:50	